

Features

- Manufactures blanks for fine and miniature crystal units.

Applications

- Blanks for crystal units.

Wafers for blanks

Model	Basic Frequency	Dimensions (mm)	Thickness	Surface Finish	Main Face Angle
1" Rectangular plate	—	25.4×25.4	0.045 min.	#4000/ polish	Angle Specified±15"
2" Rectangular plate	—	50.8×50.8	0.085 min.	#4000/ polish	Angle Specified±15"
3" Rectangular plate	—	76.2×76.2	0.200 min.	#4000/ polish	Angle Specified±60"

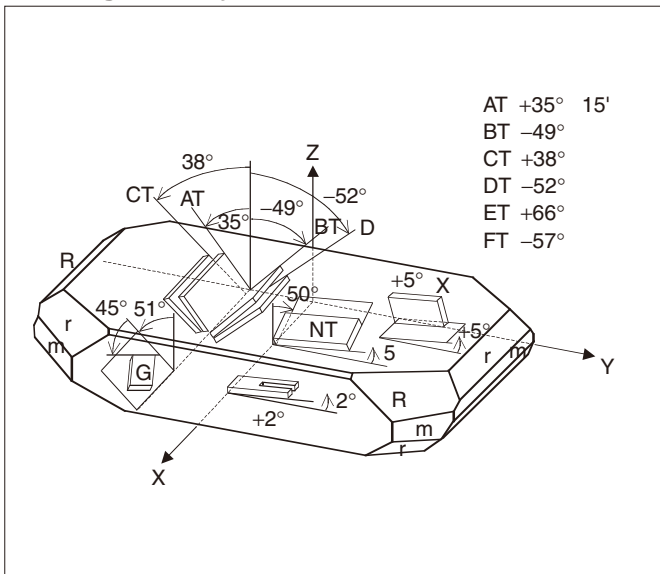
* Size and thickness other than above shall be studied upon request.

Blanks

Model	Basic Frequency	Dimensions (mm)	Surface Finish	Main Face Angle	Contour Finish
L1.4 Blank	20MHz to 80MHz	Long Side 1.4	#4000/ polish	Angle Specified±15"	#4000
L2.0 Blank	12MHz to 80MHz	Long Side 2.0	#4000/ polish	Angle Specified±15"	#4000
L3.5 Blank	10MHz to 80MHz	Long Side 3.5	#4000/ polish	Angle Specified±15"	#4000

* Size and thickness other than above shall be studied upon request.

Cut Angle of Crystal Blank



AT Cut Plate

